

## LC<sup>2</sup>MOS Precision 5 V/3 V Quad SPST Switches

#### FEATURES

+3 V, +5 V or  $\pm$ 5 V Power Supplies Ultralow Power Dissipation (<0.5  $\mu$ W) Low Leakage (<100 pA) Low On Resistance (<50  $\Omega$ ) Fast Switching Times Low Charge Injection TTL/CMOS Compatible 16-Lead DIP or SOIC Package

#### **APPLICATIONS**

Battery-Powered Instruments Single Supply Systems Remote Powered Equipment 5 V Supply Systems Computer Peripherals such as Disk Drives Precision Instrumentation Audio and Video Switching Automatic Test Equipment Precision Data Acquisition Sample Hold Systems Communication Systems Compatible with ±5 V Supply DACs and ADCs such as AD7840/AD7848, AD7870/AD7871/AD7872/AD7874/ AD7875/AD7876/AD7878

#### **GENERAL DESCRIPTION**

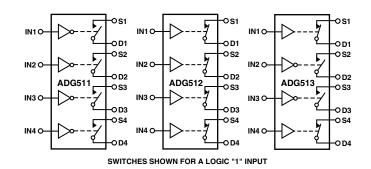
The ADG511, ADG512 and ADG513 are monolithic CMOS ICs containing four independently selectable analog switches. These switches feature low, well-controlled on resistance and wide analog signal range, making them ideal for precision analog signal switching.

These switch arrays are fabricated using Analog Devices' advanced linear compatible CMOS ( $LC^2MOS$ ) process which offers the additional benefits of low leakage currents, ultralow power dissipation and low capacitance for fast switching speeds with minimum charge injection. These features make the ADG511, ADG512 and ADG513 the optimum choice for a wide variety of signal switching tasks in precision analog signal processing and data acquisition systems.

The ability to operate from single +3 V, +5 V or  $\pm$ 5 V bipolar supplies make the ADG511, ADG512 and ADG513 perfect for use in battery-operated instruments, 4–20 mA loop systems and with the new generation of DACs and ADCs from Analog Devices. The use of 5 V supplies and reduced operating currents give much lower power dissipation than devices operating from  $\pm$ 15 V supplies.

#### FUNCTIONAL BLOCK DIAGRAMS

ADG511/ADG512/ADG513



The ADG511, ADG512 and ADG513 contain four independent SPST switches. The ADG511 and ADG512 differ only in that the digital control logic is inverted. The ADG511 switch is turned on with a logic low on the appropriate control input, while a logic high is required for the ADG512. The ADG513 contains two switches whose digital control logic is similar to that of the ADG511 while the logic is inverted in the remaining two switches.

#### **PRODUCT HIGHLIGHTS**

- 5 Volt Single Supply Operation The ADG511/ADG512/ADG513 offers high performance, including low on resistance and wide signal range, fully specified and guaranteed with +3 V, ±5 V as well as +5 V supply rails.
- 2. Ultralow Power Dissipation CMOS construction ensures ultralow power dissipation.
- 3. Low R<sub>ON</sub>
- 4. Break-Before-Make Switching

Switches are guaranteed to have break-before-make operation. This allows multiple outputs to be tied together for multiplexer applications without the possibility of momentary shorting between channels.

#### REV. C

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 One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106, U.S.A.

 Tel: 781/329-4700
 www.analog.com

 Fax: 781/326-8703
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# $\begin{array}{l} \textbf{ADG511/ADG512/ADG513} \textbf{--SPECIFICATIONS}^1 \\ \textbf{Dual Supply} (v_{\text{DD}} = +5 \ \text{V} \pm 10\%, \ v_{\text{SS}} = -5 \ \text{V} \pm 10\%, \ \text{GND} = 0 \ \text{V}, \ \text{unless otherwise noted} ) \end{array}$

|  | B Versions<br>-40°C to |                      | T Version<br>-55°C to |                      |                  |   |  |
|--|------------------------|----------------------|-----------------------|----------------------|------------------|---|--|
| Parameter  | 25°C                   | +85°C                | 25°C                  | +125°C               | Unit             | <b>Test Conditions/Comments</b>   |  |
| ANALOG SWITCH  |                        |                      |                       |                      |                  |   |  |
| Analog Signal Range  |                        | $V_{DD}$ to $V_{SS}$ | 20                    | $V_{DD}$ to $V_{SS}$ | V                |   |  |
| R <sub>ON</sub>  | 30                     | 50                   | 30                    | 50                   | Ω typ            | $V_D = \pm 3.5 \text{ V}, I_S = -10 \text{ mA};$  |  |
|  |                        | 50                   |                       | 50                   | Ω max            | $V_{DD}$ = +4.5 V, $V_{SS}$ = -4.5 V  |  |
| LEAKAGE CURRENTS   |                        |                      |                       |                      |                  | $V_{DD}$ = +5.5 V, $V_{SS}$ = -5.5 V  |  |
| Source OFF Leakage I <sub>S</sub> (OFF)                      | ±0.025                 |                      | ±0.025                |                      | nA typ           | $V_{\rm D} = \pm 4.5 \text{ V}, V_{\rm S} = \mp 4.5 \text{ V};$                             |  |
|  | ±0.1                   | $\pm 2.5$            | ±0.1                  | $\pm 2.5$            | nA max           | Test Circuit 2  |  |
| Drain OFF Leakage I <sub>D</sub> (OFF)                       | ±0.025                 |                      | ±0.025                |                      | nA typ           | $V_D = \pm 4.5 \text{ V}, V_S = \pm 4.5 \text{ V};$   |  |
|  | ±0.1                   | $\pm 2.5$            | ±0.1                  | $\pm 2.5$            | nA max           | Test Circuit 2  |  |
| Channel ON Leakage $I_D$ , $I_S$ (ON)                        | ±0.05                  |                      | ±0.05                 |                      | nA typ           | $V_{\rm D} = V_{\rm S} = \pm 4.5 \text{ V};$  |  |
|  | ±0.2                   | ±5                   | ±0.2                  | ±5                   | nA max           | Test Circuit 3  |  |
| DIGITAL INPUTS   |                        |                      |                       |                      |                  |   |  |
| Input High Voltage, V <sub>INH</sub>                         |                        | 2.4                  |                       | 2.4                  | V min            |   |  |
| Input Low Voltage, V <sub>INL</sub>                          |                        | 0.8                  |                       | 0.8                  | V max            |   |  |
| Input Current  |                        |                      |                       |                      |                  |   |  |
| I <sub>INL</sub> or I <sub>INH</sub>                         | 0.005                  |                      | 0.005                 |                      | μA typ           | $V_{IN} = V_{INL}$ or $V_{INH}$   |  |
|  |                        | $\pm 0.1$            |                       | $\pm 0.1$            | μA max           |   |  |
| DYNAMIC CHARACTERISTICS <sup>2</sup>                         |                        |                      |                       |                      |                  |   |  |
| t <sub>on</sub>  | 200                    |                      | 200                   |                      | ns typ           | $R_{\rm L} = 300 \ \Omega. \ C_{\rm L} = 35 \ pF;$  |  |
| -014   |                        | 375                  |                       | 375                  | ns max           | $V_{\rm S} = \pm 3$ V; Test Circuit 4   |  |
| t <sub>OFF</sub>   | 120                    |                      | 120                   |                      | ns typ           | $R_{L} = 300 \Omega. C_{L} = 35 pF;$  |  |
|  |                        | 150                  |                       | 150                  | ns max           | $V_s = \pm 3 V$ ; Test Circuit 4  |  |
| Break-Before-Make Time                                       | 100                    |                      | 100                   |                      | ns typ           | $R_L = 300 \Omega, C_L = 35 pF;$  |  |
| Delay, t <sub>D</sub> (ADG513 Only)                          |                        |                      |                       |                      |                  | $V_{S1} = V_{S2} = 3 V$ ; Test Circuit 5  |  |
| Charge Injection   | 11                     |                      | 11                    |                      | pC typ           | $V_{\rm S} = 0 \text{ V}, \text{ R}_{\rm S} = 0 \Omega, \text{ C}_{\rm L} = 10 \text{ nF};$ |  |
|  |                        |                      |                       |                      |                  | Test Circuit 6  |  |
| OFF Isolation  | 68                     |                      | 68                    |                      | dB typ           | $R_L = 50 \Omega, C_L = 5 pF, f = 1 MHz;$   |  |
|  |                        |                      |                       |                      |                  | Test Circuit 7  |  |
| Channel-to-Channel Crosstalk                                 | 85                     |                      | 85                    |                      | dB typ           | $R_L = 50 \Omega, C_L = 5 pF, f = 1 MHz;$   |  |
| C (OFF)  | 9                      |                      |                       |                      | T trans          | Test Circuit 8  |  |
| $C_{\rm S}$ (OFF)  | 9                      |                      | 9                     |                      | pF typ           | f = 1 MHz<br>f = 1 MHz  |  |
| C <sub>D</sub> (OFF)<br>C <sub>D</sub> , C <sub>S</sub> (ON) | 35                     |                      | 35                    |                      | pF typ<br>pF typ | f = 1 MHz   |  |
|  | 55                     |                      |                       |                      | prityp           | 1 - 1 MI12  |  |
| POWER REQUIREMENTS   |                        |                      |                       |                      |                  |   |  |
| V <sub>DD</sub>  |                        | +4.5/5.5             |                       | +4.5/5.5             | V min/max        |   |  |
| V <sub>ss</sub>  |                        | -4.5/-5.5            |                       | -4.5/-5.5            | V min/max        |   |  |
| I <sub>DD</sub>  | 0.0001                 |                      | 0.0001                |                      | μA typ           | $V_{DD} = +5.5 \text{ V}, V_{SS} = -5.5 \text{ V}$  |  |
|  |                        | 1                    |                       | 1                    | μA max           | Digital Inputs = 0 V or 5 V   |  |
| I <sub>SS</sub>  | 0.0001                 |                      | 0.0001                |                      | μA typ           |   |  |
|  |                        | 1                    |                       | 1                    | μA max           |   |  |

NOTES

<sup>1</sup>Temperature ranges are as follows: B Versions –40°C to +85°C; T Version –55°C to +125°C.

<sup>2</sup>Guaranteed by design, not subject to production test.

Specifications subject to change without notice.

### Single Supply ( $V_{DD} = 5 V \pm 10\%$ , $V_{SS} = 0 V$ , GND = 0 V, unless otherwise noted)

|   | B Versions |                   | T Version |                    |           |   |  |
|---|------------|-------------------|-----------|--------------------|-----------|---|--|
| Demonster                               | 25°C       | -40°C to<br>+85°C | 25°C      | -55°C to<br>+125°C | Unit      | Test Conditions/Comments  |  |
| Parameter                               | 25°C       | +85°C             | 250       | +125°C             | Unit      | Test Conditions/Comments  |  |
| ANALOG SWITCH                           |            |                   |           |                    |           |   |  |
| Analog Signal Range                     |            | 0 V to $V_{DD}$   |           | 0 V to $V_{DD}$    | V         |   |  |
| R <sub>ON</sub>                         | 45         |                   | 45        |                    | Ωtyp      | $V_{\rm D} = 3.5 \text{ V}, I_{\rm S} = -10 \text{ mA};$                                    |  |
|   |            | 75                |           | 75                 | Ω max     | $V_{DD} = 4.5 V$  |  |
| LEAKAGE CURRENTS                        |            |                   |           |                    |           | $V_{DD} = 5.5 V$  |  |
| Source OFF Leakage I <sub>S</sub> (OFF) | ±0.025     |                   | ±0.025    |                    | nA typ    | $V_D = 4.5/1 \text{ V}, V_S = 1/4.5 \text{ V};$   |  |
|   | ±0.1       | $\pm 2.5$         | ±0.1      | ±2.5               | nA max    | Test Circuit 2  |  |
| Drain OFF Leakage I <sub>D</sub> (OFF)  | ±0.025     |                   | ±0.025    |                    | nA typ    | $V_D = 4.5/1 \text{ V}, V_S = 1/4.5 \text{ V};$   |  |
|   | ±0.1       | $\pm 2.5$         | ±0.1      | ±2.5               | nA max    | Test Circuit 2  |  |
| Channel ON Leakage $I_D$ , $I_S$ (ON)   | ±0.05      |                   | ±0.05     |                    | nA typ    | $V_{\rm D} = V_{\rm S} = 4.5 \text{ V}/1 \text{ V};$  |  |
|   | ±0.2       | ±5                | ±0.2      | ±5                 | nA max    | Test Circuit 3  |  |
| DIGITAL INPUTS                          |            |                   |           |                    |           |   |  |
| Input High Voltage, V <sub>INH</sub>    |            | 2.4               |           | 2.4                | V min     |   |  |
| Input Low Voltage, V <sub>INL</sub>     |            | 0.8               |           | 0.8                | V max     |   |  |
| Input Current                           |            |                   |           |                    |           |   |  |
| I <sub>INL</sub> or I <sub>INH</sub>    | 0.005      |                   | 0.005     |                    | μA typ    | $V_{IN} = V_{INL}$ or $V_{INH}$   |  |
|   |            | $\pm 0.1$         |           | $\pm 0.1$          | μA max    |   |  |
| DYNAMIC CHARACTERISTICS <sup>2</sup>    |            |                   |           |                    |           |   |  |
| t <sub>ON</sub>                         | 250        |                   | 250       |                    | ns typ    | $R_L = 300 \Omega$ , $C_L = 35 pF$ ;  |  |
|   |            | 500               |           | 500                | ns max    | $V_s = 2 V$ ; Test Circuit 4  |  |
| t <sub>OFF</sub>                        | 50         |                   | 50        |                    | ns typ    | $R_L = 300 \Omega$ , $C_L = 35 pF$ ;  |  |
|   |            | 100               |           | 100                | ns max    | $V_S = 2 V$ ; Test Circuit 4  |  |
| Break-Before-Make Time                  | 200        |                   | 200       |                    | ns typ    | $R_L = 300 \Omega$ , $C_L = 35 pF$ ;  |  |
| Delay, t <sub>D</sub> (ADG513 Only)     |            |                   |           |                    |           | $V_{S1} = V_{S2} = 2 V$ ; Test Circuit 5  |  |
| Charge Injection                        | 16         |                   | 16        |                    | pC typ    | $V_{\rm S} = 0 \text{ V}, \text{ R}_{\rm S} = 0 \Omega, \text{ C}_{\rm L} = 10 \text{ nF};$ |  |
|   |            |                   |           |                    | 15        | Test Circuit 6  |  |
| OFF Isolation                           | 68         |                   | 68        |                    | dB typ    | $R_L = 50 \Omega$ , $C_L = 5 pF$ , $f = 1 MHz$ ;<br>Test Circuit 7                          |  |
| Channel-to-Channel Crosstalk            | 85         |                   | 85        |                    | dB typ    | $R_L = 50 \Omega$ , $C_L = 5 pF$ , $f = 1 MHz$ ;  |  |
| Channel-to-Channel Crosstark            | 60         |                   | 65        |                    | автур     | $R_L = 50.22$ , $C_L = 5 \text{ pr}$ , $1 = 1 \text{ MHz}$ ,<br>Test Circuit 8              |  |
| C <sub>S</sub> (OFF)                    | 9          |                   | 9         |                    | pF typ    | f = 1 MHz   |  |
| $C_{\rm D}$ (OFF)                       | 9          |                   | 9         |                    | pF typ    | f = 1 MHz   |  |
| $C_D, C_S$ (ON)                         | 35         |                   | 35        |                    | pF typ    | f = 1 MHz   |  |
| POWER REQUIREMENTS                      |            |                   |           |                    |           |   |  |
| V <sub>DD</sub>                         |            | 4.5/5.5           |           | 4.5/5.5            | V min/max |   |  |
| I <sub>DD</sub>                         | 0.0001     | 1.2,2.2           | 0.0001    | 1.2,2.2            | μA typ    | $V_{DD} = 5.5 V$  |  |
| -עע                                     |            | 1                 | 0.0001    | 1                  | μA max    | $D_{DD} = 3.5$ V<br>Digital Inputs = 0 V or 5 V   |  |
|   |            | *                 |           | -                  |           |   |  |

NOTES

<sup>1</sup>Temperature ranges are as follows: B Versions –40°C to +85°C; T Version –55°C to +125°C.

<sup>2</sup>Guaranteed by design, not subject to production test.

Specifications subject to change without notice.

# ADG511/ADG512/ADG513-SPECIFICATIONS<sup>1</sup>

**Single Supply** ( $V_{DD} = 3.3 V \pm 10\%$ ,  $V_{SS} = 0 V$ , GND = 0 V, unless otherwise noted)

|   | B Ve   | rsion           |                              |   |
|---|--------|-----------------|------------------------------|---|
| Parameter                               | 25°C   | 0°C to<br>70°C  | Unit                         | Test Conditions/Comments  |
| ANALOG SWITCH                           |        |                 |                              |   |
| Analog Signal Range                     | 200    | 0 V to $V_{DD}$ |                              | $X_{i} = 1 \subset X_{i} T = 1$   |
| R <sub>ON</sub>                         | 200    | 500             | $\Omega$ typ<br>$\Omega$ max | $V_D = 1.5 V, I_S = -1 mA;$<br>$V_{DD} = 3 V$   |
| LEAKAGE CURRENTS                        |        |                 |                              | V <sub>DD</sub> = 3.6 V   |
| Source OFF Leakage I <sub>S</sub> (OFF) | ±0.025 |                 | nA typ                       | $V_D = 2.6/1 \text{ V}, V_S = 1/2.6 \text{ V};$   |
|   | ±0.1   | $\pm 2.5$       | nA max                       | Test Circuit 2  |
| Drain OFF Leakage $I_D$ (OFF)           | ±0.025 |                 | nA typ                       | $V_{\rm D}$ = 2.6/1 V, $V_{\rm S}$ = 1/2.6 V;   |
|   | ±0.1   | $\pm 2.5$       | nA max                       | Test Circuit 2  |
| Channel ON Leakage $I_D$ , $I_S$ (ON)   | ±0.05  |                 | nA typ                       | $V_{\rm D} = V_{\rm S} = 2.6 \text{ V/1 V};$  |
|   | ±0.2   | ±5              | nA max                       | Test Circuit 3  |
| DIGITAL INPUTS                          |        |                 |                              |   |
| Input High Voltage, V <sub>INH</sub>    |        | 2.4             | V min                        |   |
| Input Low Voltage, V <sub>INL</sub>     |        | 0.8             | V max                        |   |
| Input Current                           |        |                 |                              |   |
| I <sub>INL</sub> or I <sub>INH</sub>    | 0.005  |                 | μA typ                       | $V_{IN} = V_{INL}$ or $V_{INH}$   |
|   |        | $\pm 0.1$       | μA max                       |   |
| DYNAMIC CHARACTERISTICS <sup>2</sup>    |        |                 |                              |   |
| t <sub>ON</sub>                         | 600    |                 | ns typ                       | $R_L = 300 \Omega$ , $C_L = 35 pF$ ;  |
|   |        | 1200            | ns max                       | $V_{S} = 1 V$ ; Test Circuit 4  |
| t <sub>OFF</sub>                        | 100    |                 | ns typ                       | $R_L = 300 \Omega$ , $C_L = 35 pF$ ;  |
|   |        | 160             | ns max                       | $V_s = 1 V$ ; Test Circuit 4  |
| Break-Before-Make Time                  | 500    |                 | ns typ                       | $R_{L} = 300 \Omega, C_{L} = 35 \text{ pF};$  |
| Delay, t <sub>D</sub> (ADG513 Only)     |        |                 |                              | $V_{S1} = V_{S2} = 1$ V; Test Circuit 5   |
| Charge Injection                        | 11     |                 | pC typ                       | $V_{\rm S} = 0 \text{ V}, \text{ R}_{\rm S} = 0 \Omega, \text{ C}_{\rm L} = 10 \text{ nF};$ |
| OFF Isolation                           | 68     |                 | dB two                       | Test Circuit 6<br>$R_L = 50 \Omega$ , $C_L = 5 pF$ , $f = 1 MHz$ ;                          |
| OFF Isolation                           | 00     |                 | dB typ                       | $R_L = 50.22$ , $C_L = 5$ pr, $T = 1$ MHz,<br>Test Circuit 7                                |
| Channel-to-Channel Crosstalk            | 85     |                 | dB typ                       | $R_{L} = 50 \Omega$ , $C_{L} = 5 pF$ , $f = 1 MHz$ ;  |
| Ghannel-to-Ghannel Grosstalk            |        |                 |                              | Test Circuit 8  |
| C <sub>S</sub> (OFF)                    | 9      |                 | pF typ                       | f = 1  MHz  |
| $C_{\rm D}$ (OFF)                       | 9      |                 | pF typ                       | f = 1 MHz   |
| $C_D, C_S$ (ON)                         | 35     |                 | pF typ                       | f = 1 MHz   |
| POWER REQUIREMENTS                      |        |                 |                              |   |
| V <sub>DD</sub>                         |        | 3/3.6           | V min/max                    |   |
| I <sub>DD</sub>                         | 0.0001 |                 | μA typ                       | $V_{DD} = 3.6 V$  |
|   |        | 1               | μA max                       | Digital Inputs = $0 \text{ V or } 3 \text{ V}$  |

NOTES <sup>1</sup>Temperature range is as follows: B Version –40°C to +85°C.

<sup>2</sup>Guaranteed by design, not subject to production test.

Specifications subject to change without notice.

#### ABSOLUTE MAXIMUM RATINGS<sup>1</sup>

 $(T_A = +25^{\circ}C \text{ unless otherwise noted})$ 

| (-A  |
|--|
| $V_{DD}$ to $V_{SS}$   |
| $V_{DD}$ to GND $\hdots0.3$ V to +25 V   |
| V <sub>SS</sub> to GND +0.3 V to -25 V   |
| Analog, Digital Inputs <sup>2</sup> $V_{SS} - 2 V$ to $V_{DD} + 2 V$ or  |
| 30 mA, Whichever Occurs First  |
| Continuous Current, S or D 30 mA   |
| Peak Current, S or D 100 mA  |
| (Pulsed at 1 ms, 10% Duty Cycle max)   |
| Operating Temperature Range  |
| Industrial (B Version)   |
| Extended (T Version) $\dots \dots \dots$ |
| Storage Temperature Range  |
| Junction Temperature 150°C   |
| Cerdip Package, Power Dissipation 900 mW   |
| $\theta_{JA}$ Thermal Impedance  |
| Lead Temperature, Soldering (10 sec) 300°C   |
|  |

| Plastic Package, Power Dissipation   | . 470 mW          |
|--------------------------------------|-------------------|
| $\theta_{JA}$ Thermal Impedance      | 117°C/W           |
| Lead Temperature, Soldering (10 sec) | 260°C             |
| SOIC Package, Power Dissipation      | . 600 mW $$       |
| $\theta_{JA}$ Thermal Impedance      | . $77^{\circ}C/W$ |
| Lead Temperature, Soldering          |                   |
| Vapor Phase (60 sec)                 | 215°C             |
| Infrared (15 sec)                    | 220°C             |

#### NOTES

<sup>1</sup>Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Only one absolute maximum rating may be applied at any one time.

<sup>2</sup>Overvoltages at IN, S or D will be clamped by internal diodes. Current should be limited to the maximum ratings given.

#### **CAUTION**

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the ADG511/ADG512/ADG513 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high-energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



#### **ORDERING GUIDE**

| Model <sup>1</sup>     | Temperature Range <sup>2</sup>     | Package Option <sup>3</sup> |
|------------------------|------------------------------------|-----------------------------|
| ADG511BN               | -40°C to +85°C                     | N-16                        |
| ADG511BR               | -40°C to +85°C                     | R-16A                       |
| ADG511ABR <sup>4</sup> | -40°C to +85°C                     | R-16A                       |
| ADG511TQ <sup>4</sup>  | –55°C to +125°C                    | Q-16                        |
| ADG512BN               | $-40^{\circ}$ C to $+85^{\circ}$ C | N-16                        |
| ADG512BR               | -40°C to +85°C                     | R-16A                       |
| ADG512ABR <sup>4</sup> | $-40^{\circ}$ C to $+85^{\circ}$ C | R-16A                       |
| ADG513BN               | $-40^{\circ}$ C to $+85^{\circ}$ C | N-16                        |
| ADG513BR               | -40°C to +85°C                     | R-16A                       |
| ADG513ABR <sup>4</sup> | $-40^{\circ}$ C to $+85^{\circ}$ C | R-16A                       |

NOTES

<sup>1</sup>For availability of MIL-STD-883, Class B processed parts, contact factory.

<sup>2</sup>3.3 V specifications apply over 0°C to 70°C temperature range.

<sup>3</sup>N = Plastic DIP; R = 0.15" Small Outline IC (SOIC); Q = Cerdip.

<sup>4</sup>Trench isolated latch-up proof parts. See Trench Isolation section.

#### PIN CONFIGURATION (DIP/SOIC)

| IN1<br>D1<br>S1<br>V <sub>SS</sub><br>GND<br>S4<br>D4<br>IN4 | 2<br>3<br>4<br>5 | ADG511     ADG512     ADG513     TOP VIEW  (Not to Scale) | 15<br>14<br>13<br>12 | IN2<br>D2<br>S2<br>V <sub>DD</sub><br>NC<br>S3<br>D3<br>IN3 |  |
|--|------------------|---|----------------------|---|--|
| NC = NO CONNECT  |                  |   |                      |   |  |

#### Truth Table (ADG511/ADG512)

| ADG511<br>In | ADG512<br>In | Switch<br>Condition |
|--------------|--------------|---------------------|
| 0            | 1            | ON                  |
| 1            | 0            | OFF                 |

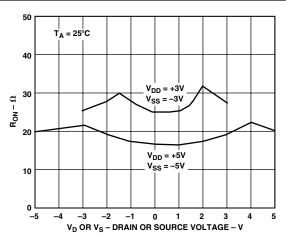
#### Truth Table (ADG513)

| Logic | Switch<br>1, 4 | Switch 2, 3 |
|-------|----------------|-------------|
| 0     | OFF            | ON          |
| 1     | ON             | OFF         |

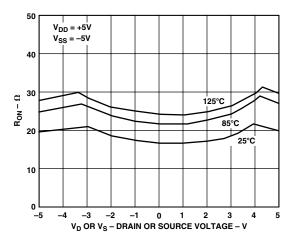
#### TERMINOLOGY

| $V_{DD}$                    | Most Positive Power Supply Potential.   |
|-----------------------------|---|
| V <sub>SS</sub>             | Most Negative Power Supply Potential in<br>dual supplies. In single supply applications,<br>it may be connected to GND.       |
| GND                         | Ground (0 V) Reference.   |
| S                           | Source Terminal. May be an input or output.   |
| D                           | Drain Terminal. May be an input or output.  |
| IN                          | Logic Control Input.  |
| R <sub>ON</sub>             | Ohmic Resistance between D and S.   |
| I <sub>S</sub> (OFF)        | Source Leakage Current with the switch "OFF."   |
| I <sub>D</sub> (OFF)        | Drain Leakage Current with the switch "OFF."  |
| $I_D$ , $I_S$ (ON)          | Channel Leakage Current with the switch "ON."   |
| $V_{\rm D}$ ( $V_{\rm S}$ ) | Analog Voltage on terminals D, S.   |
| C <sub>S</sub> (OFF)        | "OFF" Switch Source Capacitance.  |
| C <sub>D</sub> (OFF)        | "OFF" Switch Drain Capacitance.   |
| $C_D, C_S (ON)$             | "ON" Switch Capacitance.  |
| t <sub>ON</sub>             | Delay between applying the digital control input and the output switching on.   |
| t <sub>OFF</sub>            | Delay between applying the digital control input and the output switching off.  |
| t <sub>D</sub>              | "OFF" or "ON" time measured between the 90% points of both switches when switching from one address state to another.         |
| Crosstalk                   | A measure of unwanted signal which is<br>coupled through from one channel to<br>another as a result of parasitic capacitance. |
| Off Isolation               | A measure of unwanted signal coupling through an "OFF" switch.  |
| Charge Injection            | A measure of the glitch impulse transferred<br>from the digital input to the analog output<br>during switching.               |

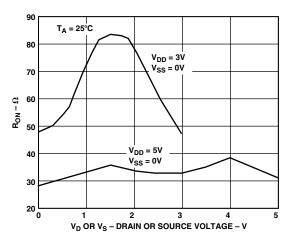
### Typical Performance Characteristics-ADG511/ADG512/ADG513



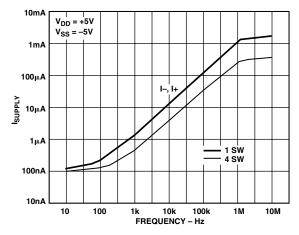
TPC 1. On Resistance as a Function of  $V_{\rm D}\,(V_{\rm S})$  Dual Supplies



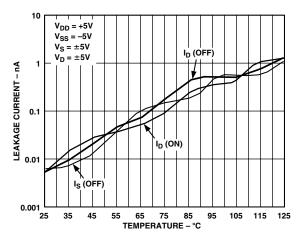
TPC 2. On Resistance as a Function of  $V_{\rm D}$  (V\_{\rm S}) for Different Temperatures



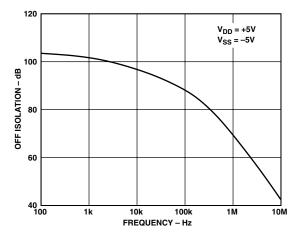
TPC 3. On Resistance as a Function of  $V_{\rm D}$  (V\_s) Single Supply



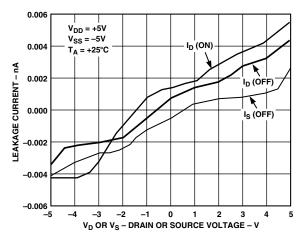
TPC 4. Supply Current vs. Input Switching Frequency



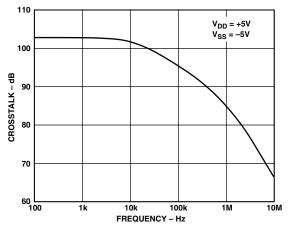
TPC 5. Leakage Currents as a Function of Temperature



TPC 6. Off Isolation vs. Frequency



TPC 7. Leakage Currents as a Function of  $V_D$  ( $V_S$ )



TPC 8. Crosstalk vs. Frequency

#### APPLICATION

Figure 1 illustrates a precise sample-and-hold circuit. An AD845 is used as the input buffer while the output operational amplifier is an OP07. During the track mode, SW1 is closed and the output  $V_{OUT}$  follows the input signal  $V_{IN}$ . In the hold mode, SW1 is opened and the signal is held by the hold capacitor  $C_{H}$ .

Due to switch and capacitor leakage, the voltage on the hold capacitor will decrease with time. The ADG511/ADG512/ADG513 minimizes this droop due to its low leakage specifications. The droop rate is further minimized by the use of a polystyrene hold capacitor. The droop rate for the circuit shown is typically 15  $\mu$ V/ $\mu$ s.

A second switch, SW2, which operates in parallel with SW1, is included in this circuit to reduce pedestal error. Since both switches will be at the same potential, they will have a differential effect on the op amp OP07, which will minimize charge injection effects. Pedestal error is also reduced by the compensation network  $R_C$  and  $C_C$ . This compensation network also reduces the hold time glitch while optimizing the acquisition time. Using the illustrated op amps and component values, the pedestal error has a maximum value of 5 mV over the ±3 V input range. The acquisition time is 2.5 µs while the settling time is 1.85 µs.

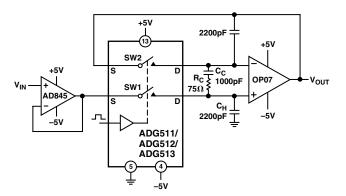


Figure 1. Accurate Sample-and-Hold

#### TRENCH ISOLATION

The MOS devices that make up the ADG511A/ADG512A/ ADG513A are isolated from each other by an oxide layer (trench) (see Figure 2). When the NMOS and PMOS devices are not electrically isolated from each other, there exists the possibility of "latch-up" caused by parasitic junctions between CMOS transistors. Latch-up is caused when P-N junctions that are normally reverse biased, become forward biased, causing large currents to flow. This can be destructive.

CMOS devices are normally isolated from each other by *Junction Isolation*. In Junction Isolation the N and P wells of the CMOS transistors form a diode that is reverse biased under normal operation. However, during overvoltage conditions, this diode becomes forward biased. A Silicon-Controlled Rectifier (SCR)type circuit is formed by the two transistors, causing a significant amplification of the current that, in turn, leads to latch-up. With Trench Isolation, this diode is removed; the result is a latch-up-proof circuit.

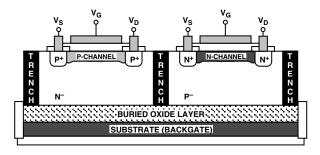
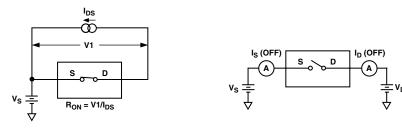
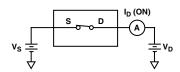


Figure 2. Trench Isolation

### **Test Circuits**

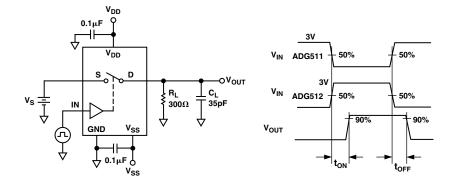




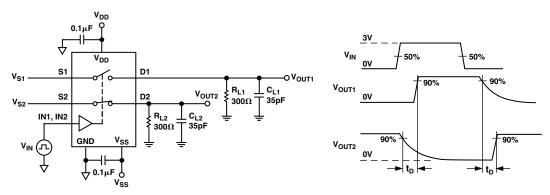
Test Circuit 1. On Resistance

Test Circuit 2. Off Leakage

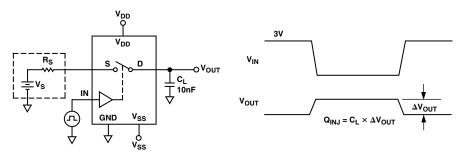
Test Circuit 3. On Leakage



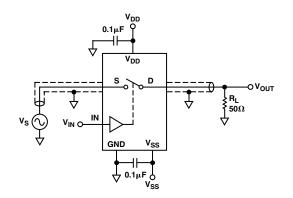
Test Circuit 4. Switching Times

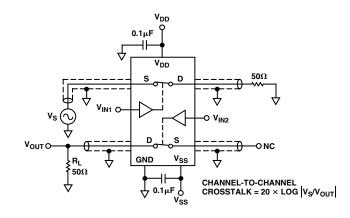


Test Circuit 5. Break-Before-Make Time Delay



Test Circuit 6. Charge Injection



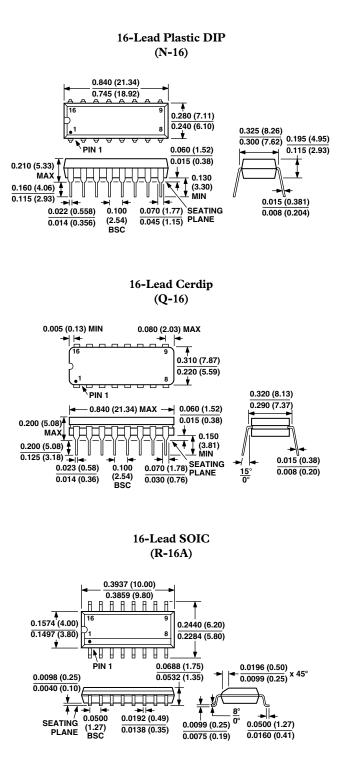


Test Circuit 8. Channel-to-Channel Crosstalk

Test Circuit 7. Off Isolation

#### **OUTLINE DIMENSIONS**

Dimensions shown in inches and (mm).



### ADG511/ADG512/ADG513-Revision History

#### Location

| Data Sheet changed from REV. B to REV. C.   |   |
|---|---|
| Changes to Specifications table, Dual Supply, and Notes: "T Versions" made singular   | 2 |
| Changes to Specifications table, Single Supply, and Notes: "T Versions" made singular | 3 |
| Change to Ordering Guide: Removed one line  | 5 |

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